XCZU19EG-L1FFVC1760I Information

Part Number	XCZU19EG-L1FFVC1760I
Manufacturer	Xilinx Inc.
Category	Integrated Circuits (ICs)
	Embedded - System On Chip (SoC)
Description	IC FPGA 512 I/O 1760FCBGA
Package	1760-BBGA, FCBGA

For the pricing/inventory/lead time, please contact us
Website: https://www.heisener.com
E-mail: salesdept@heisener.com

For Reference Only

Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.

XCZU19EG-L1FFVC1760I Specifications

Manufacturer Part Number	XCZU19EG-L1FFVC1760I
Manufacturer	Xilinx Inc.
Category	Integrated Circuits (ICs)
	Embedded - System On Chip (SoC)
Package	1760-BBGA, FCBGA
Series	Zynq? UltraScale+? MPSoC EG
Architecture	MCU, FPGA
Core Processor	Quad ARM? Cortex?-A53 MPCore? with CoreSight?, Dual ARM?Cortex?-R5 with CoreSight?
Flash Size	-
RAM Size	256KB
Peripherals	DMA, WDT
Connectivity	CAN, EBI/EMI, Ethernet, I2C, MMC/SD/SDIO, SPI, UART/USART, USB OTG
Speed	600MHz, 1.5GHz
Primary Attributes	Zynq?UltraScale+? FPGA, 1143K+ Logic Cells
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	1760-BBGA, FCBGA
Supplier Device Package	1760-FCBGA (42.5x42.5)
	Report errors?

XCZU19EG-L1FFVC1760I Guarantees

Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

XCZU19EG-L1FFVC1760I Payment Methods

XCZU19EG-L1FFVC1760I Shipping Methods

If you have any question about XCZU19EG-L1FFVC1760I, please do not hesitate to contact us!

Website: https://www.heisener.com

E-mail: salesdept@heisener.com